

IN THE CLAIMS

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

1. (Currently amended) A method for patterning-transferring an ink pattern to a surface of a substrate with an ink, the method comprising the acts of:

providing an elastomeric stamp having a bulk surface and at least one protruding feature protruding from the bulk surface, the protruding feature having a contact surface and an edge extending from the contact surface to the bulk surface; ~~providing a barrier layer covering the contact surface and the edge on the protruding feature and the bulk surface;~~

applying a solution of the ink and a solvent to the barrier layer, the barrier layer preventing molecules of the ink from penetrating the elastomeric stamp; ~~removing the solvent from the barrier layer; providing a first substrate with a surface having a higher affinity for the ink than the barrier layer;~~

contacting the contact surface of the protruding feature with the a surface of the a first substrate; transferring, the surface of the first substrate having a higher affinity for the ink than the barrier layer, the contacting resulting in a transfer of all of the ink from the contact surface of the protruding feature to the surface of the first substrate; ~~removing the elastomeric stamp from the surface of the first substrate such that none of the ink remains~~

on the contact surface of the protruding feature due to the ~~acts of contacting, transferring all of the ink from the contact surface and removing;~~ providing a second substrate with a surface of the first substrate having a higher affinity for the ink than the barrier layer; and contacting the contact surface of the protruding feature with ~~the a surface of the a~~ second substrate, the surface of the second substrate having a higher affinity for the ink than the barrier layer; and transferring wherein the ink pattern is transferred from the edge of the protruding feature to the surface of the second substrate.

2. (Currently amended) The method as claimed in claim 1, further comprising the an act of removing a part of the surface of the second substrate ~~the part being defined by~~ the ink pattern.

3. (Currently amended) The method as claimed in claim 2, wherein the removing of the part of the surface of the second substrate comprises an etching act.

4. (Currently amended) The method of claim 1, wherein the act of ~~providing~~ contacting the surface of the second substrate is performed for a period of time to allow lateral movement over the surface of the second substrate of the ink transferred from the edge.

5. (New) The method of claim 1, further comprising an act of removing the solvent from the barrier layer.

6. (New) The method of claim 1, wherein an increase in the contact time between the contact surface of the protruding feature and the surface of the second substrate results in the transfer of an increasing fraction of the ink from the edges to the surface of the second substrate.